

RoHS

## AOW190A60C-VB Datasheet

N-Channel 600V (D-S) Super Junction Power MOSFET

PRODUCT SUMMARY			
V <sub>DS</sub> (V) at T <sub>J</sub> max.	600		
R <sub>DS(on)</sub> at 25 °C (Ω)	$V_{GS} = 10 V$	0.150	

### **FEATURES**

- Low figure-of-merit (FOM) R<sub>on</sub> x Q<sub>g</sub>
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)

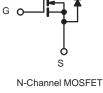
### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting



TO-262

Top View



D

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> :	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V <sub>DS</sub>	600	V		
Gate-Source Voltage			V <sub>GS</sub>	± 30	V	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$V_{\rm ext} = 0.10$ V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub> -	20		
	$V_{GS}$ at 10 V $$	T <sub>C</sub> = 100 °C		12	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	60		
Linear Derating Factor			1.67	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	900	mJ	
Maximum Power Dissipation			PD	160	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		-l\ / / -lt	50		
Reverse Diode dV/dt <sup>d</sup>		dV/dt	15	V/ns		
Soldering Recommendations (Peak Temperature) c for 10 s		10 s		260	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature. b.  $V_{DD} = 100 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 30mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 13A$ .

c. 1.6 mm from case. d.  $I_{SD} \le I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C.

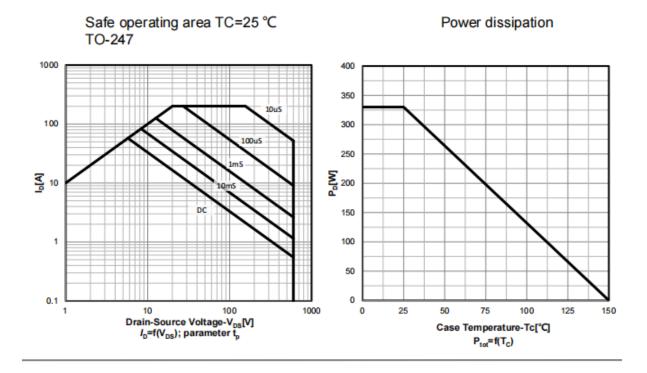


THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62 0.38				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-				°C/W		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	-	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	Vcs	= 0 V, I <sub>D</sub> =	1 mA	600	_	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			, I <sub>D</sub> = 1 mA	_	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	-	= V <sub>GS</sub> , I <sub>D</sub> =		2.5	-	4.5	V
	• GS(III)		$V_{GS} = \pm 20$		- 2.5	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30$		_	-	± 100	
			= 600V, V <sub>G</sub>		_		1	μΑ 
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		-	V, T <sub>J</sub> = 125 °C		-	100	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{DS} = 480 V_{CS} = 10 V$	7, VGS – 0	$I_{\rm D} = 7A$	-	0.150	-	Ω
Forward Transconductance	g <sub>fs</sub>	Vns	s = 30 V, I <sub>D</sub>	) = 7A	-	5.6	-	S
Dynamic	0.0		,,.	,		I		
Input Capacitance	C <sub>iss</sub>		<u>۱</u>	,	_	2300	-	
Output Capacitance	Coss	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		-	330	-	1	
Reverse Transfer Capacitance	C <sub>rss</sub>	-	f = 1 MHz		-	4	-	1
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 V$ to 520 V, $V_{GS} = 0 V$		-	63	-	pF	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	213	-		
Total Gate Charge	Qg				-	62	-	<u>†</u>
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 20 A, V <sub>DS</sub> = 520 V		-	39	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>				-	47	-	1
Turn-On Delay Time	t <sub>d(on)</sub>				-	18	25	
Rise Time	t <sub>r</sub>	Vnn	$V_{DD}=520 \text{ V}, \text{ I}_{D}=20\text{A},$ $V_{GS}=10 \text{ V}, \text{ R}_{g}=9.1 \ \Omega$		-	24	55	ns
Turn-Off Delay Time	t <sub>d(off)</sub>				-	80	-	
Fall Time	t <sub>f</sub>	V <sub>GS</sub> :			-	12	-	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.8	-	Ω	
Drain-Source Body Diode Characteristic	s					_		
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	20		
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	60	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 8 A	A, V <sub>GS</sub> = 0 V	-	-	1.5	V
Reverse Recovery Time	t <sub>rr</sub>	-	-		-	520	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>		25 °C, I <sub>F</sub> =		-	5.8	-	μC
Reverse Recovery Current	I <sub>RRM</sub>	dl/dt = '	100 A/µs, '	V <sub>R</sub> = 400 V	-	4 5	-	A

#### Notes

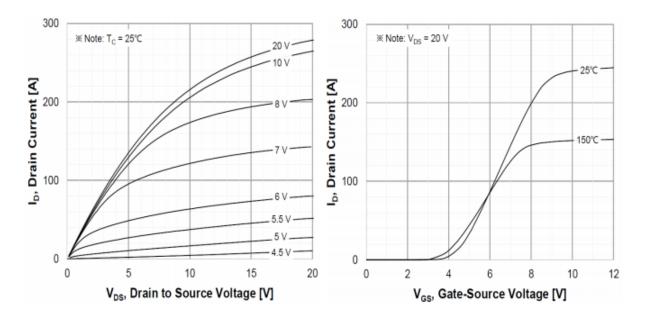
a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



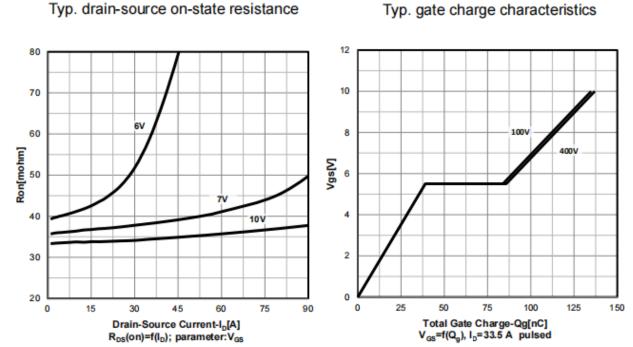


Typ. output characteristics  $T_i$ =25  $^{\circ}C$ 

Transfer characteristics



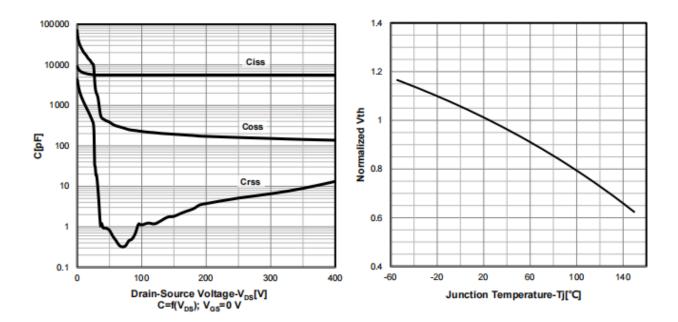




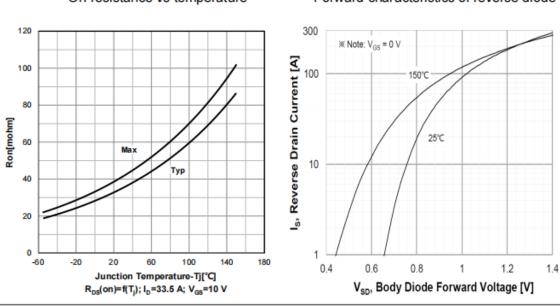
Typ. drain-source on-state resistance

Typ. capacitances

Normalized  $V_{GS(th)}$  characteristics



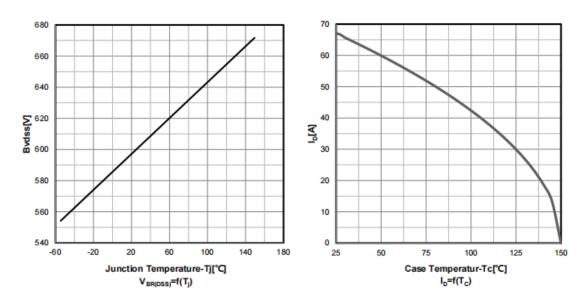




On-resistance vs temperature Forward characteristics of reverse diode

Drain-source breakdown voltage

Drain current vs temperature

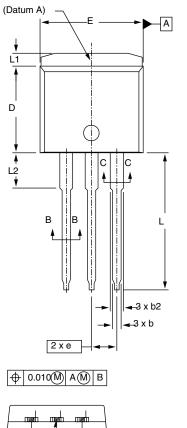


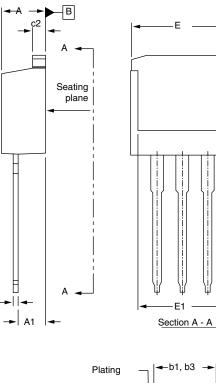


D1

Base

### I<sup>2</sup>PAK (TO-262)





с -

INCHES

MAX.

0.190

0.119

0.039

0.035

0.070

0.068

0.029

0.023

0.065

MIN.

0.160

0.080

0.020

0.020

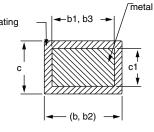
0.045

0.045

0.015

0.015

0.045



Section B - B and C	- C
Scale: None	

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D	8.38	9.65	0.330	0.380
D1	6.86	-	0.270	-
E	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	-
е	2.54 BSC		0.100 BSC	
L	13.46	14.10	0.530	0.555
L1	-	1.65	-	0.065
L2	3.56	3.71	0.140	0.146

N	otoe

DIM.

А

A1

b

b1

b2

b3 c

c1

c2

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outmost extremes of the plastic body.

3. Thermal pad contour optional within dimension E, L1, D1, and E1.4

. Dimension b1 and c1 apply to base metal only.

Lead tip

MIN.

4.06

2.03

0.51

0.51

1.14

1.14

0.38

0.38

1.14

MILLIMETERS

MAX.

4.83

3.02

0.99

0.89

1.78

1.73

0.74

0.58

1.65



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